CEL

CMOS INTEGRATED CIRCUIT

μPD5713TK

WIDE BAND SPDT SWITCH

DESCRIPTION

The μPD5713TK is a CMOS MMIC for wide band SPDT (Single Pole Double Throw) switch which were developed for mobile communications, wireless communications and another general-purpose RF switching application.

This device can operate frequency from 0.05 to 2.5 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin lead-less minimold (1511) package. And this package is able to high-density surface mounting.

FEATURES

- Supply voltage : V_{DD} = 1.8 to 3.6 V (2.8 V TYP.)
- Switch control voltage : $V_{cont\ (H)}$ = 1.8 to 3.6 V (2.8 V TYP.)
  : $V_{cont\ (L)}$ = −0.2 to +0.4 V (0 V TYP.)
- Low insertion loss : $L_{ins}1$ = 0.6 dB TYP. @ f = 0.05 to 1.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
  : $L_{ins}2$ = 0.8 dB TYP. @ f = 1.0 to 2.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
  : $L_{ins}3$ = 0.95 dB TYP. @ f = 2.0 to 2.5 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
- High isolation : ISL1 = 32.5 dB TYP. @ f = 0.05 to 1.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
  : ISL2 = 25 dB TYP. @ f = 1.0 to 2.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
  : ISL3 = 22.5 dB TYP. @ f = 2.0 to 2.5 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
- Handling power : $P_{in\ (1\ dB)}$ = +21.0 dBm TYP. @ f = 1.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
  : $P_{in\ (0.1\ dB)}$ = +17.0 dBm TYP. @ f = 1.0 GHz, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V
- High-density surface mounting : 6-pin lead-less minimold package (1.5 × 1.1 × 0.55 mm)

APPLICATIONS

- Mobile communications
- Wireless communications
- Another general-purpose RF switching applications

ORDERING INFORMATION

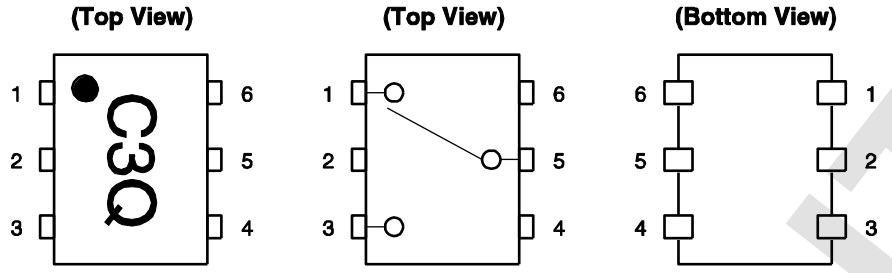
Part Number	Order Number	Package	Marking	Supplying Form
μPD5713TK-E2	μPD5713TK-E2-A	6-pin lead-less minimold (1511) (Pb-Free)	C3Q	• Embossed tape 8 mm wide • Pin 1, 6 face the perforation side of the tape • Qty 5 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPD5713TK-A

Caution: Observe precautions when handling because these devices are sensitive to electrostatic discharge

Document No. PU10627EJ01V0DS (1st edition)
Date Published September 2006 NS CP(K)

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	OUTPUT1
2	GND
3	OUTPUT2
4	V_{cont}
5	INPUT
6	V_{DD}

TRUTH TABLE

V_{cont}	INPUT–OUTPUT1	INPUT–OUTPUT2
Low	OFF	ON
High	ON	OFF

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V_{DD}	–0.5 to +4.6	V
Switch Control Voltage	V_{cont}	–0.5 to +4.6	V
Voltage Difference	$V_{cont (H)} - V_{DD}$	+0.5	V
Input Power	P_{in}	+23	dBm
Operating Ambient Temperature	T_A	–45 to +85	°C
Storage Temperature	T_{stg}	–55 to +150	°C

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V_{DD}	+1.8	+2.8	+3.6	V
Switch Control Voltage (H)	$V_{cont (H)}$	+1.8	+2.8	+3.6	V
Switch Control Voltage (L)	$V_{cont (L)}$	–0.2	0	+0.4	V

Remark $V_{DD} - 0.4\ V \leq V_{cont (H)} \leq V_{DD} + 0.2\ V$

ELECTRICAL CHARACTERISTICS

(T_A = +25°C, V_{DD} = 2.8 V, $V_{cont\,(H)}$ = 2.8 V, $V_{cont\,(L)}$ = 0 V, DC cut capacitors = 1 000 pF, unless otherwise specified)

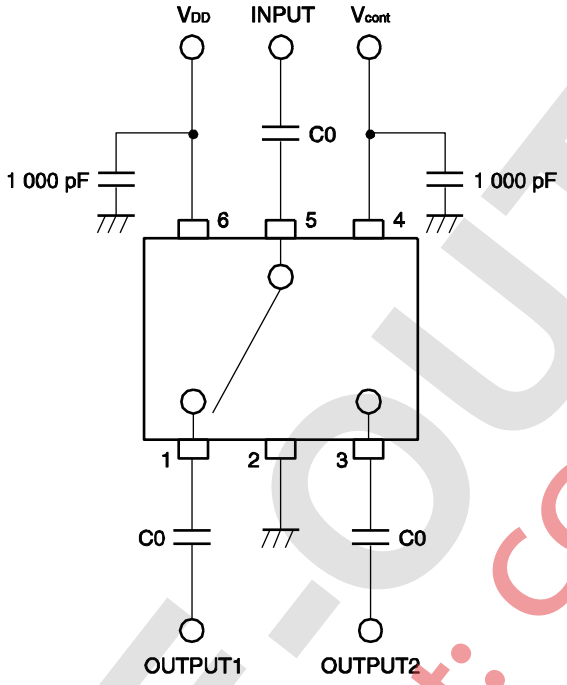
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	$L_{ins}1$	f = 0.05 to 1.0 GHz	–	0.6	0.8	dB
Insertion Loss 2	$L_{ins}2$	f = 1.0 to 2.0 GHz	–	0.8	1.0	dB
Insertion Loss 3	$L_{ins}3$	f = 2.0 to 2.5 GHz	–	0.95	1.2	dB
Isolation 1	ISL1	f = 0.05 to 1.0 GHz	30	32.5	–	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz	22	25	–	dB
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	20	22.5	–	dB
Input Return Loss	RL_{in}	f = 0.05 to 2.5 GHz	13	17	–	dB
Output Return Loss	RL_{out}	f = 0.05 to 2.5 GHz	13	17	–	dB
0.1 dB Loss Compression Input Power Note 1	$P_{in\,(0.1\,dB)}$	f = 1.0 GHz	+13.0	+17.0	–	dBm
1 dB Loss Compression Input Power Note 2	$P_{in\,(1\,dB)}$	f = 1.0 GHz	–	+21.0	–	dBm
Supply Current	I_{DD}	V_{DD} = V_{cont} = 2.8 V, RF off	–	0.01	1.0	μA
Switch Control Current	I_{cont}	V_{DD} = V_{cont} = 2.8 V, RF off	–	0.01	1.0	μA
Switch Control Speed	t_{SW}	f = 1.0 GHz	–	30	100	ns

Notes 1. $P_{in\,(0.1\,dB)}$ is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

2. $P_{in\,(1\,dB)}$ is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution This device is used it is necessary to use DC cut capacitors.
The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system.

EVALUATION CIRCUIT

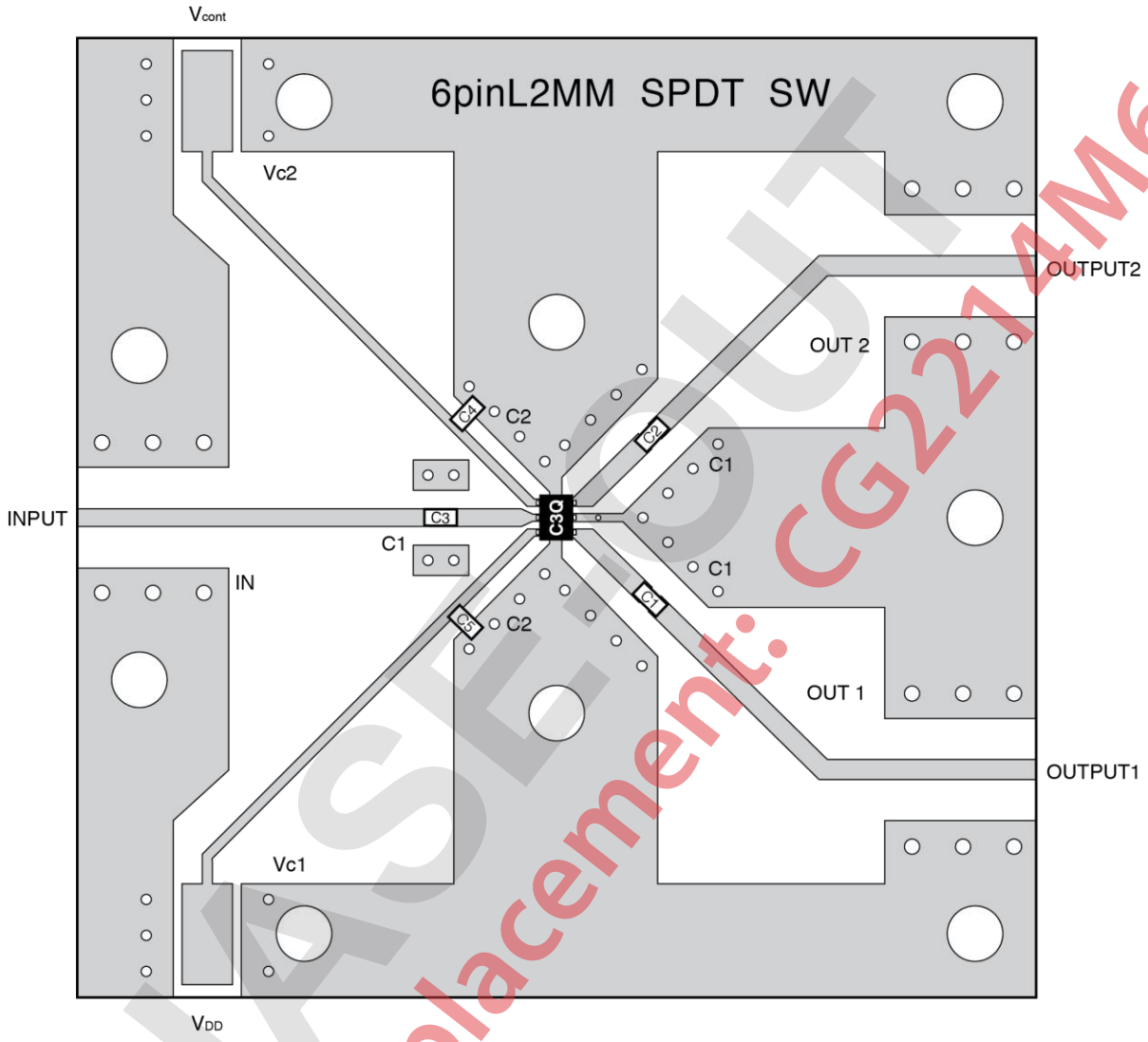


Remark C0 = 1 000 pF

Caution This IC has pull down resistance between RF line and GND, witch fixes electric potential of RF line to 0 V, then the IC cannot be used for DC switching.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD



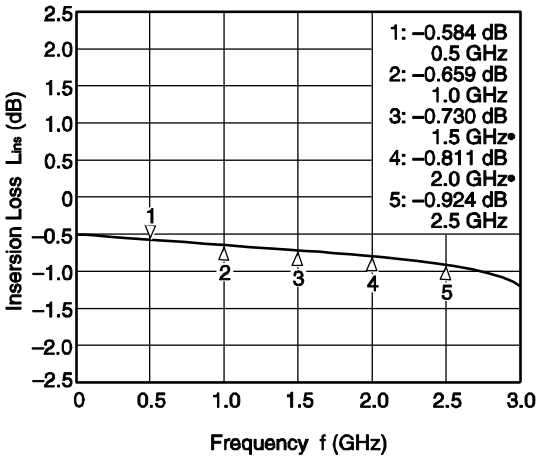
USING THE EVALUATION BOARD

Symbol	Values
C1, C2, C3	1 000 pF
C4, C5	1 000 pF

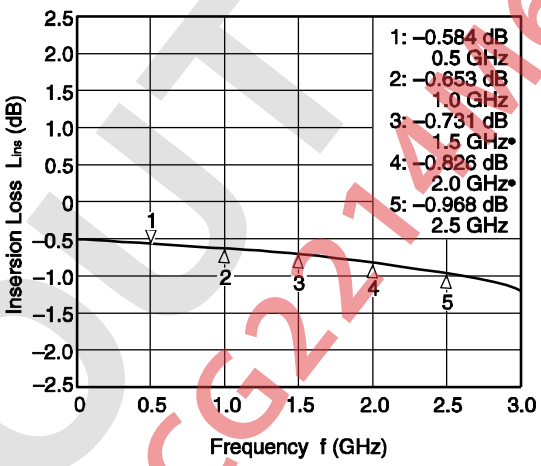
TYPICAL CHARACTERISTICS

(T_A = +25°C, V_{DD} = 2.8 V, $V_{cont\ (H)}$ = 2.8 V, $V_{cont\ (L)}$ = 0 V, P_{in} = 0 dBm, DC cut capacitors = 1 000 pF, unless otherwise specified)

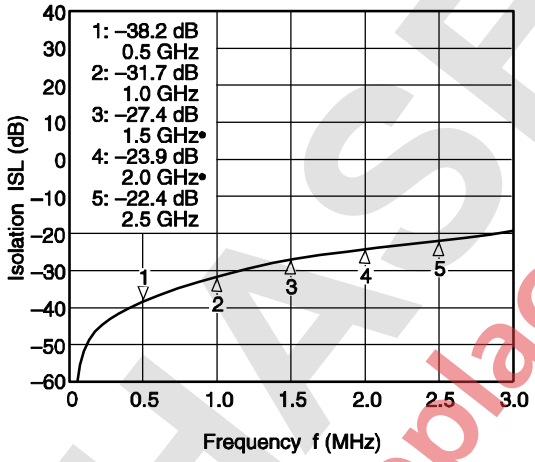
INPUT–OUTPUT1 •
INSERSION LOSS vs. FREQUENCY



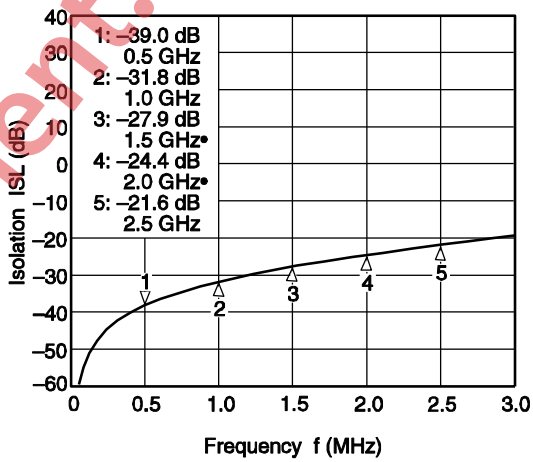
INPUT–OUTPUT2 •
INSERSION LOSS vs. FREQUENCY



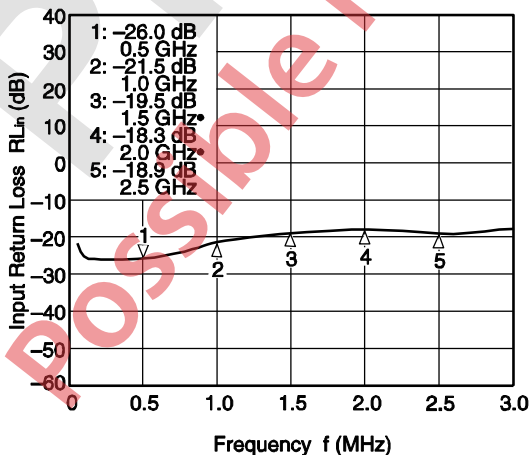
INPUT–OUTPUT1 •
ISOLATION vs. FREQUENCY



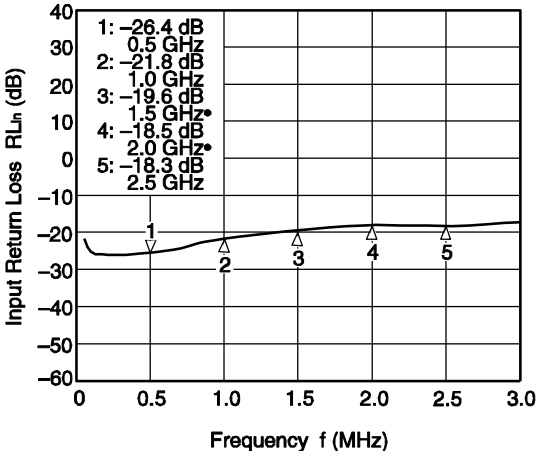
INPUT–OUTPUT2 •
ISOLATION vs. FREQUENCY



INPUT–OUTPUT1 •
INPUT RETURN LOSS vs. FREQUENCY

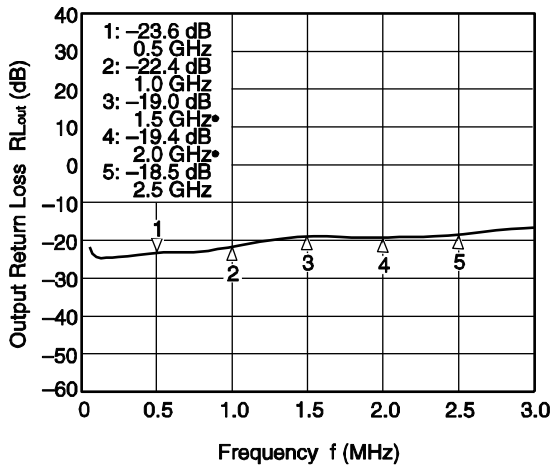


INPUT–OUTPUT2 •
INPUT RETURN LOSS vs. FREQUENCY

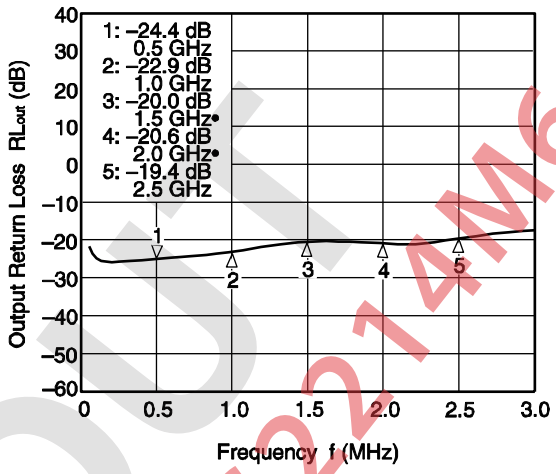


Remark The graphs indicate nominal characteristics.

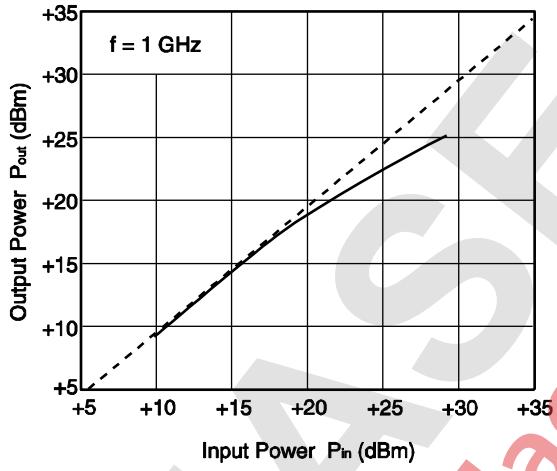
INPUT–OUTPUT1 •
OUTPUT RETURN LOSS vs. FREQUENCY



INPUT–OUTPUT2 •
OUTPUT RETURN LOSS vs. FREQUENCY



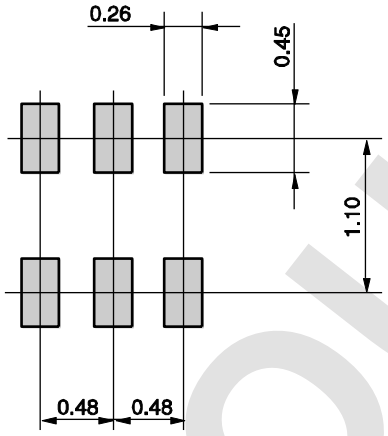
OUTPUT POWER vs. INPUT POWER



Remark The graphs indicate nominal characteristics.

MOUNTING PAD DIMENSIONS

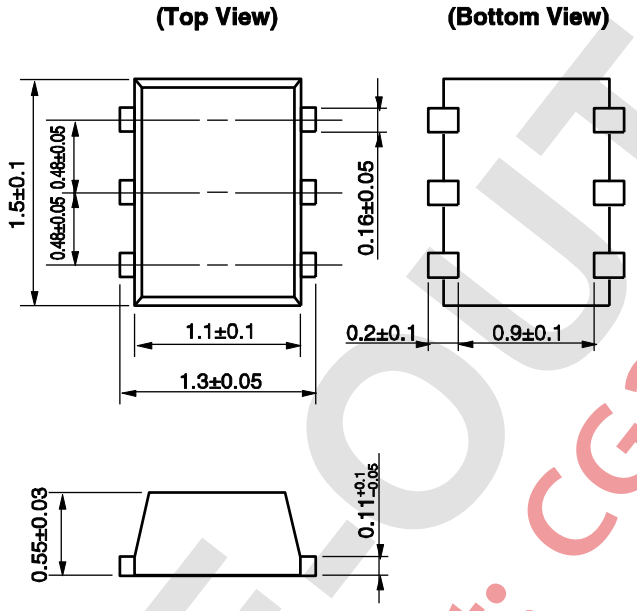
6-PIN LEAD-LESS MINIMOLD (1511) (UNIT: mm)



Remark The mounting pad layouts in this document are for reference only.

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511) (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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